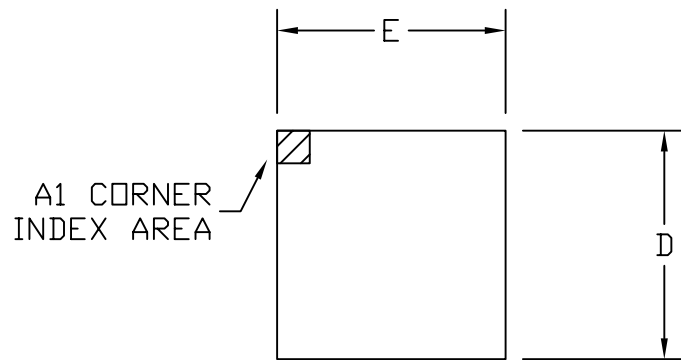
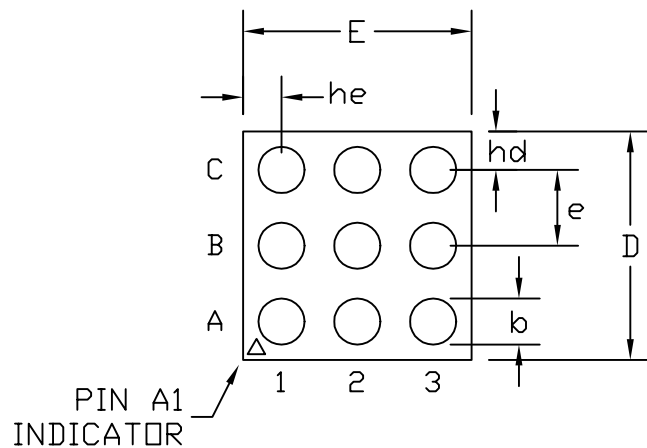




TOP VIEW



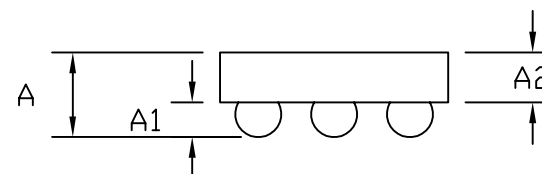
BOTTOM VIEW

SYMBOL	DIMENSIONS
A	0.60±0.05
D	1.52±0.05
E	1.52±0.05
e	0.50 BASIC
b	ø 0.35 BASIC
A1	0.27±0.04
A2	0.33 Ref.
hd	0.26 Ref.
he	0.26 Ref.

SOLDER BALL DEPOPULATION	
PKG. CODE	DEPOPULATED BALL
B9-1	NONE
B9-2	B2
B9-3	B1, B2, B3

NOTES:

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. MEETS JEDEC M0195.



SIDE VIEW

MAXIM			
PROPRIETARY INFORMATION			
TITLE: PACKAGE OUTLINE, 3x3 UCSP			
APPROVAL	DOCUMENT CONTROL NO. 21-0093	REV. E	1/1